

СВЕТОДИОДЫ BEELED – ТЕХНИЧЕСКОЕ ОПИСАНИЕ

MODEL: 3014W2C-KHC-E

Features

- 1 . Chip material: InGaN.
- 2 · Emitted color: super White.
- 4 \ Low power consumption.
- 5 \ High efficiency.
- 6 Versatile mounting on P.C.Board or panel.
- 7 \ Low current requirement.
- 8 · 3mm diameter package.
- 9 · This product don't Contained restriction Substance, compliance ROHS standard.

Usage Notes:

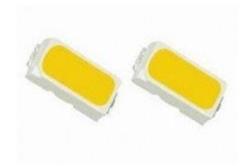
- Surge will damage the LED
- When using LED, it must use a protective resistor in series with DC current about 150mA

Applications

- 1 · For a variety of electronic products, light sources and the state, outdoor signal instructions.
- 2 · A variety of lighting project and indoor and outdoor Lighting.
- 3 \ Recreational facilities, a variety of media, images and performances such as art lighting.
- 4 \ Infrared transmitting and receiving control.

Device Selection Guide

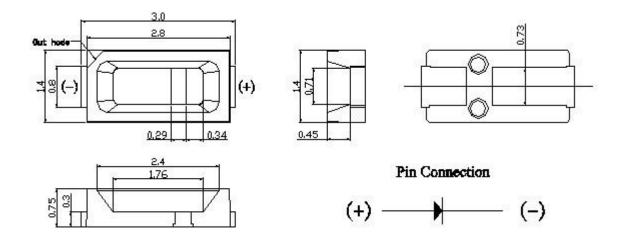
LED Part No.	Chip		
	Material	Emitted Color	Lens Color
3014W2C-KHC-E	InGaN	White	Yellow diffused





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Package Dimensions



Notes:

- 1 · All dimension are in millimeters(inches)
- 2 \ Tolerance is_0.25mm(0.01)unless otherwise specified.
- 3 Lead spacing is measured where the leads emerge from the package.
- 4 · Specifications are subject to change without notice.



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Absolute Maximum Rating (Ta=25°C)

Parameter	Symbol	Absolute Maximum Rating	Unit	
Peak Forward Current	le	75	mA	
(Duty 1/10 @1KHz)	IF.	75	IIIA	
Forward Current	I _{FM}	30	mA	
Reverse Voltage	V _R	15	V	
Power Dissipation	P _D	0.1	W	
Operating Temperature	Topr	-25~+85	°C	
Storage Temperature	Tstg	-40~+85	°C	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec.		
Soldering Temperature		Hand Soldering : 320 ℃ for	3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	
Luminous Intensity	Iv			Lm	IF=30mA(Note1)		
Lummous intensity	11	12		14	LIII		
Viewing Angle	$2\theta_{1/2}$		120		Deg	(Note 2)	
Color developing index	Ra		80		%	IF=30mA	
Correlated Color Temperature	CCT	6000-7000K		nm	IF=30mA		
Forward Voltage	V_{F}	2.9		3.4	V	IF=30mA	
Reverse Current	I_R			10	μΑ	VR=5V	

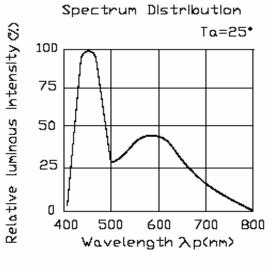
Note:

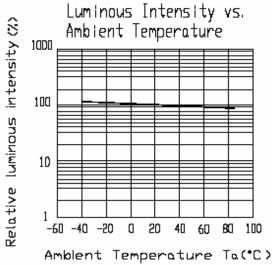
- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

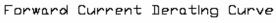


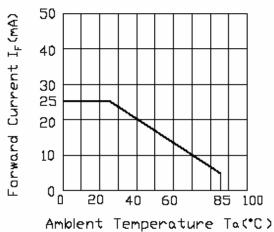
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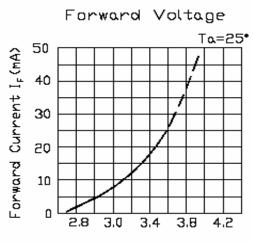
Typical Electro-Optical Characteristics Curves



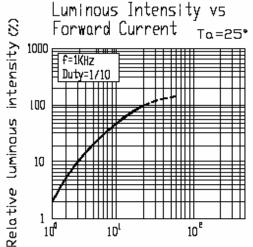


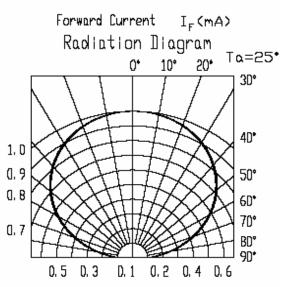






Forward Voltage(V)-volts







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Reliability Test Items And Conditions

No	Item	Test Condition	Sample Number	Criteria for Judging	Ac/Re
1	Solderability	$T=235\pm5$ °C $T=5$ sec.	15	Good wetting	0/1
			15	IV≥LSL*	
2	Soldering heat	$T=260\pm5$ °C $T=10$ sec.		VF≪USL*	0/1
				IR≶USL	
	Rapid change of temperature followed by: damp heat, cyclic	L:-40°C 10min			
3 te		(2~3) min			
		H:+100°C 10min		IV≥LSL	
		5cycle	11	VF≶USL	0/1
		T= (25~55) ℃	11	VI'≪USL IR≪USL	0/1
		RH: (90~95) %		IK < OSL	
		2cycle 48h			
		recovery time 2h			
	Damp heat, cyclic	T=(25~55)°C		IV≥0.7LSL	
4		RH= (90~95) %	11	VF≤1.1USL	0/1
4		6 cycle 144h		IR≤2USL	0/1
		recovery time 2h		IK \2002	
5 El		I_=30mA	22	IV≥0.7LSL	
	Electrical endurance	F		VF≤1.1USL	0/1
		T=1000h		IR≤2USL	
6	Storage at high temperature	$T_{\text{stg}} = 100 \pm 2 ^{\circ}\text{C}$	15	IV≥LSL	
		stg		VF≤USL	0/1
		t=1000h		IR≤USL	
7	Terminal strength	Tensile: W=5N t= 30s	15	No damage	0/1
,		Bending: W=2.5N 2times	13		

*U.S.L.: Upper Standard Level

* L.S.L.: Lower Standard Level



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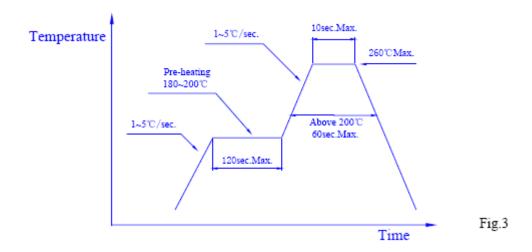
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APPLICATION NOTES:

- 1)Soldering:
- 1 Manual soldering by soldering iron:

The use of a soldering iron of less than 25W is recommended and the temperature of the iron must be kept at no higher than 300°C.

- (2) Reflow soldering:
- a. The temperature profile as shown in Fig.3 is recommended for soldering SMD LED by the reflow furnace.
- b. Care must be taken that the products be handled after their temperature has dropped down to the normal room temperature after soldering.



Solder = Sn63-Pb37	Solder = Lead-Free		
Average ramp-up rate = 4° C/sec. max.	Average ramp-up rate = 4° C/sec. max		
Preheat temperature: 100~150°C	Preheat temperature: 150~200°C		
Preheat time = 100 sec. max.	Preheat time = 100 sec. max.		
Ramp-down rate = 6° C/sec. max.	Ramp-down rate = 6° C/sec. max.		
Peak temperature = 230° C max.	Peak temperature = 260°C max.		
Time within 5° C of actual peak temperature = 10 sec.	Time within 5° C of actual peak temperature = 10 sec.		
max.	max.		
Duration above 183°C is 80 sec. max.	Duration above 217°C is 80 sec. max.		



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2)Post solder cleaning:

When cleaning after soldering is needed, the following conditions must be adhered to.

- 1 Cleaning solvents: Freon TF or equivalent or alcohol.
- (2) Temperature: 50°C Max.for 30 seconds or 30°CMax.for 3 minutes
- (3) Ultrasonic: 300W Max.
- 3) OTHERS:
- a. Care must be taken not to cause stress to the epoxy resin portion of SMD LED while it is exposed to the high temperature.
- b. Care must be taken not to the rub the epoxy resin portion of SMD LED with a hard or sharp edged article such as the sand blast and the metal hook as the epoxy resin is rather soft and liable to be damaged.